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MITSUBISHI SEMICONDUCTOR < Dual-In-Line Package Intelligent Power Module>

PS22053

TRANSFER-MOLD TYPE **INSULATED TYPE**

PS22053



INTEGRATED POWER FUNCTIONS

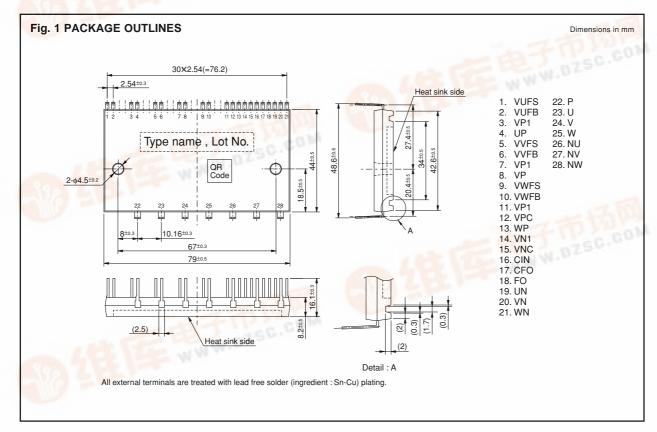
1200V/10A low-loss 4th generation IGBT inverter bridge for 3 phase DC-to-AC power conversion WWW.DZSC.CO

INTEGRATED DRIVE, PROTECTION AND SYSTEM CONTROL FUNCTIONS

- For upper-leg IGBTs: Drive circuit, High voltage high-speed level shifting, Control supply under-voltage (UV) protection.
- For lower-leg IGBTs: Drive circuit, Control supply under-voltage protection (UV), Short circuit protection (SC). WWW.DZSC.CO
- · Fault signaling: Corresponding to an SC fault (Lower-side IGBT) or a UV fault (Lower-side supply).
- Input interface: 5V line CMOS/TTL compatible (High active logic).

APPLICATION

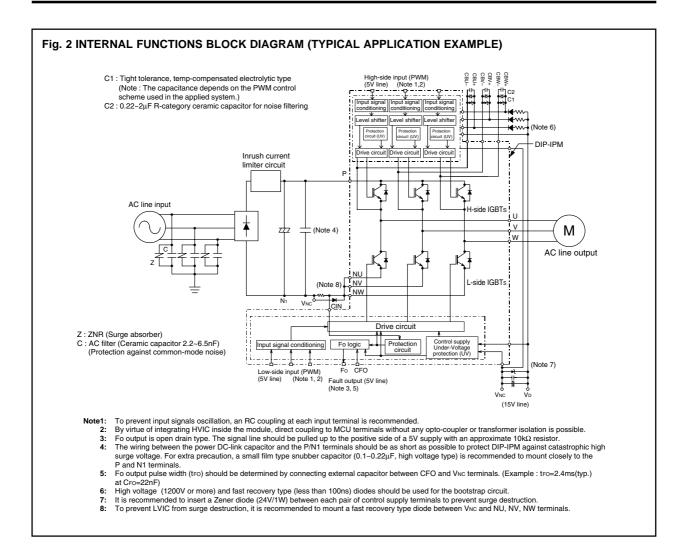
AC400V 0.2kW~0.75kW inverter drive for small power motor control.

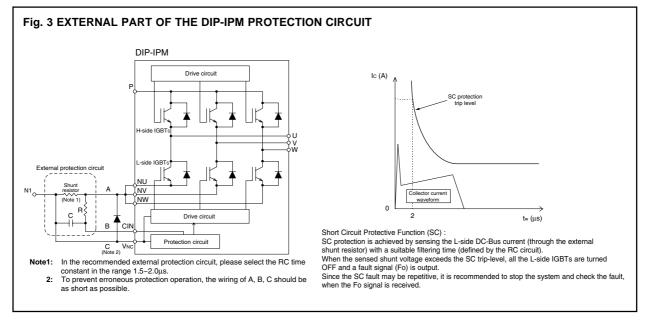






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MAXIMUM RATINGS (Tj = 25° C, unless otherwise noted) **INVERTER PART**

Symbol	Parameter	Condition	Ratings	Unit
Vcc	Supply voltage	Applied between P-NU, NV, NW	900	V
VCC(surge)	Supply voltage (surge)	Applied between P-NU, NV, NW	1000	V
VCES	Collector-emitter voltage		1200	V
±lc	Each IGBT collector current	Tc = 25°C	10	Α
±ICP	Each IGBT collector current (peak)	Tc = 25°C, less than 1ms	20	Α
Pc	Collector dissipation	Tc = 25°C, per 1 chip	50.0	W
Tj	Junction temperature	(Note 1)	-20~+125	°C

Note 1 : The maximum junction temperature rating of the power chips integrated within the DIP-IPM is 150° C (@ Tc $\leq 100^{\circ}$ C) however, to ensure safe operation of the DIP-IPM, the average junction temperature should be limited to Tj(ave) $\leq 125^{\circ}$ C (@ Tc $\leq 100^{\circ}$ C).

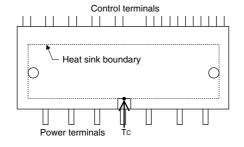
CONTROL (PROTECTION) PART

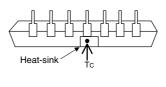
Symbol	Parameter	Condition Ratings		Unit
VD	Control supply voltage	Applied between VP1-VPC, VN1-VNC	20	V
VDB	Control supply voltage	Applied between Vufb-Vufs, Vvfb-Vvfs, Vwfb-Vwfs	20	٧
VIN	Input voltage	Applied between UP, VP, WP-VPC, UN, VN, WN-VNC	-0.5~VD+0.5	V
VFO	Fault output supply voltage	Applied between Fo-VNC	-0.5~VD+0.5	V
IFO	Fault output current	Sink current at Fo terminal	1	mA
Vsc	Current sensing input voltage	Applied between CIN-VNC	-0.5~VD+0.5	V

TOTAL SYSTEM

Symbol	Parameter	Condition Ratings		Unit
VCC(PROT)	Self protection supply voltage limit (short circuit protection capability)	VD = 13.5~16.5V, Inverter part T_j = 125°C, non-repetitive, less than 2 μs		٧
Tc	Module case operation temperature	(Note 2)	− 20~+100	°C
Tstg	Storage temperature		− 40~+125	°C
Viso	Isolation voltage	60Hz, Sinusoidal, AC 1 minute, connection pins to heat-sink plate	2500	Vrms

Note 2: TC MEASUREMENT POINT







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THERMAL RESISTANCE

Symbol Parameter	Darameter	Condition	Limits			Unit
	Condition		Тур.	Max.		
Rth(j-c)Q	Junction to case thermal Inverter IGBT part (per 1/6 module)		_	_	2.00	°C/W
Rth(j-c)F	resistance	Inverter FWDi part (per 1/6 module)	_	_	2.67	°C/W
Rth(c-f)	Contact thermal resistance (Note 3)	Case to fin, (per 1 module) thermal grease applied	_	_	0.047	°C/W

Note 3: Grease with good thermal conductivity and long-term endurance should be applied evenly with about +100μm~+200μm on the contacting surface of DIP-IPM and heat-sink.

ELECTRICAL CHARACTERISTICS ($T_j = 25^{\circ}C$, unless otherwise noted) **INVERTER PART**

Symbol Parameter		Condition		Limits			1.1
Symbol	Parameter	Condition		Min.	Тур.	Max.	Unit
VCE(sat)	Collector-emitter saturation	VD = VDB = 15V	VD = VDB = 15V		2.7	3.4	.,
V CE(Sai)	voltage	VIN = 5V, IC = 10A	Tj = 125°C	_	2.5	3.2	V
VEC	FWDi forward voltage	-IC = 10A, VIN = 0V		_	2.5	3.0	V
ton		VCC = 600V, VD = VDB = 15V IC = 10A, T_j = 125°C, VIN = 0 ↔ 5V		0.8	1.5	2.2	μs
trr				_	0.2	_	μs
tc(on)	Switching times			_	0.4	0.7	μs
toff		Inductive load (upper-lov	Inductive load (upper-lower arm)		2.8	3.8	μs
tc(off)				_	0.4	0.7	μs
ICES	Collector-emitter cut-off		Tj = 25°C	-	_	1	mA
current VCE = VCES		Tj = 125°C	_	_	10	111/4	

CONTROL (PROTECTION) PART

Cumple al	Devementer		0	aditi a sa		Limits		Unit
Symbol	Parameter	Condition			Min.	Тур.	Max.	Unit
		VD = VDB = 15V	Total of	f VP1-VPC, VN1-VNC	_	_	3.70	mA
In	Circuit current	VIN = 5V	VUFB-V	UFS, VVFB-VVFS, VWFB-VWFS	_	_	1.30	mA
ID	Circuit current	VD = VDB = 15V	Total of	FVP1-VPC, VN1-VNC	_	_	3.50	mA
		VIN = 0V	VUFB-V	UFS, VVFB-VVFS, VWFB-VWFS	_	_	1.30	mA
VFOH	- Fault output voltage	Vsc = 0V, Fo circuit pull-up to 5V with $10k\Omega$			4.9	_	_	٧
VFOL	- Fault output voltage	VSC = 1V, IFO = 1mA			_	_	1.10	V
VSC(ref)	Short circuit trip level	$T_j = 25^{\circ}C, V_D = 15V$ (Note 4)		0.43	0.48	0.53	V	
lin	Input current	VIN = 5V	VIN = 5V			1.5	2.0	mA
UVDBt				Trip level	10.0	_	12.0	V
UVDBr	Supply circuit under-voltage	T _i ≤ 125°C		Reset level	10.5	_	12.5	V
UVDt	protection	1] ≤ 125°C		Trip level	10.3	_	12.5	V
UVDr				Reset level	10.8	_	13.0	V
tFO	Fault output pulse width	CFO = 22nF (Note 5)		1.6	2.4		ms	
Vth(on)	ON threshold voltage	Applied between I	Applied between LID, VD, WD, VDO, LIN, VA, WA, VA,		2.0	3.0	4.2	V
Vth(off)	OFF threshold voltage	Applied between UP, VP, WP-VPC, UN, VN, WN-VNC			0.8	1.4	2.0	V

Note 4: Short circuit protection is functioning only at the low-arms. Please select the value of the external shunt resistor such that the SC trip-level is less than 1.7 times device current rating.



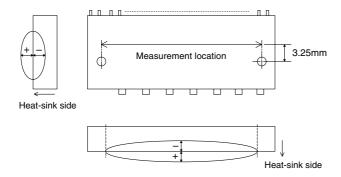
^{5:} Fault signal is output when the low-arms short circuit or control supply under-voltage protective functions operate. The fault output pulsewidth tFO depends on the capacitance value of CFO according to the following approximate equation: CFO = 9.3 × 10⁻⁶ × tFO [F].

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MECHANICAL CHARACTERISTICS AND RATINGS

Dovometer	Condition		Limits			Limit
Parameter	Con	Min.	Тур.	Max.	Unit	
Mounting torque	Mounting screw : M4 Recommended 1.18 N·m		0.98	_	1.47	N·m
Weight			_	77	_	g
Heat-sink flatness (Note 6)		-50	_	100	μm	

Note 6: Measurement point of heat-sink flatness



RECOMMENDED OPERATION CONDITIONS

O:l	L Deremeter Condition				Limits	Limits	
Symbol	Parameter	Condition		Min.	Тур.	Max.	Unit
Vcc	Supply voltage	Applied between P-NU, NV, NW		350	600	800	٧
VD	Control supply voltage	Applied between VP1-VPC, VN1-VNC		13.5	15.0	16.5	V
VDB	Control supply voltage	Applied between VUFB-VUFS, VVFB-VV	VFS, VWFB-VWFS	13.5	15.0	16.5	V
ΔV D, ΔV DB	Control supply variation			-1	_	1	V/µs
tdead	Arm shoot-through blocking time	For each input signal, Tc ≤ 100°C		3.3	_	_	μs
fPWM	PWM input frequency	Tc ≤ 100°C, Tj ≤ 125°C		_	_	15	kHz
		VCC = 600V, VD = 15V, fC = 15kHz					
lo	Output r.m.s. current	P.F = 0.8, sinusoidal PWM		_	_	3.4	Arms
		$T_j \le 125^{\circ}C$, $T_C \le 100^{\circ}C$ (Note 7)					
PWIN(on)			(Note 8)	1.5	_	_	
		350 ≤ VCC ≤ 800V,					
		$13.5 \le V_D \le 16.5V$,	Ic ≤ 10A	2.5	_	_	
	Minimum input pulse width	$13.5 \le VDB \le 16.5V$,					μs
PWIN(off)		-20°C ≤ Tc ≤ 100°C,					
		N line wiring inductance less than	10 < lc ≤ 17A	2.7	_	_	
		10nH (Note 9)					
VNC	VNC variation	Between VNC-NU, NV, NW (including	surge)	-5.0	_	5.0	V

Note 7: The output r.m.s. current value depends on the actual application conditions.

8: DIP-IPM might not make response to the input on signal with pulse width less than PWIN (on).

9: DIP-IPM might not make response or work properly if the input off signal pulse width is less than PWIN (off).



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Fig. 4 THE DIP-IPM INTERNAL CIRCUIT

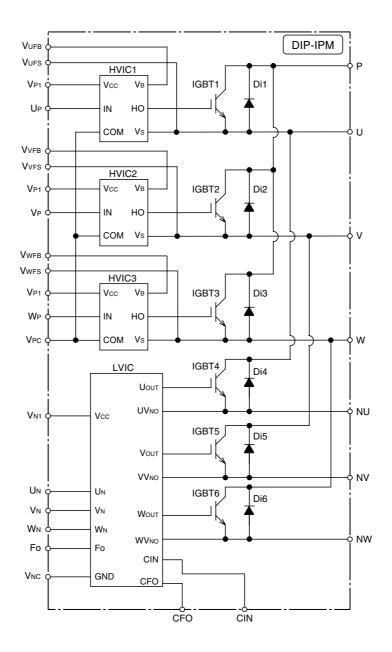
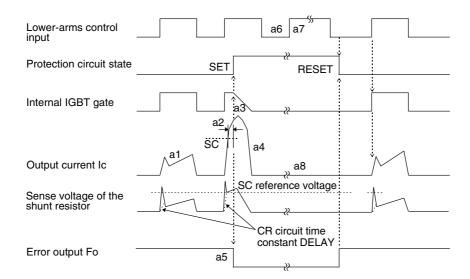




Fig. 5 TIMING CHARTS OF THE DIP-IPM PROTECTIVE FUNCTIONS

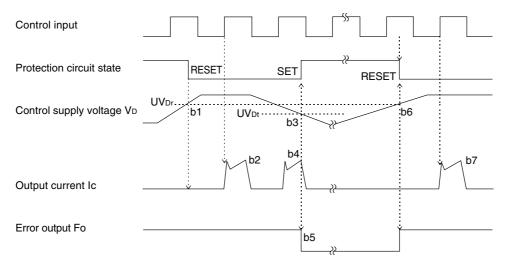
[A] Short-Circuit Protection (Lower-arms only with the external shunt resistor and CR filter)

- a1. Normal operation: IGBT ON and carrying current.
- a2. Short circuit current detection (SC trigger).
- a3. IGBT gate hard interruption.
- a4. IGBT turns OFF.
- a5. Fo output with a fixed pulse width determined by the external capacitor CFO.
- a6. Input = "L": IGBT OFF
- a7. Input = "H":
- a8. IGBT OFF state in spite of input "H".



[B] Under-Voltage Protection (Lower-arm, UVD)

- b1. Control supply voltage rising: After the voltage level reaches UVDr, the circuits start to operate when next input is applied. b2. Normal operation: IGBT ON and carrying current.
- b3. Under voltage trip (UVDt).
- b4. IGBT OFF in spite of control input condition.
- b5. Fo keeps output during the UV period, however, Fo pulse is not less than the fixed width for very short UV interval.
- b6. Under voltage reset (UVDr)
- b7. Normal operation: IGBT ON and carrying current.





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[C] Under-Voltage Protection (Upper-side, UVDB)

- c1. Control supply voltage rises: After the voltage reaches UVDBr, the circuits start to operate when next input is applied. c2. Normal operation: IGBT ON and carrying current. c3. Under voltage trip (UVDBt). c4. IGBT OFF in spite of control input signal level, but there is no Fo signal output.

- c5. Under voltage reset (UVDBr)
- c6. Normal operation: IGBT ON and carrying current.

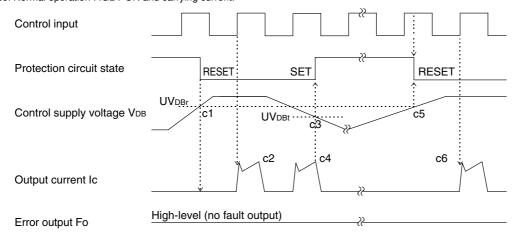
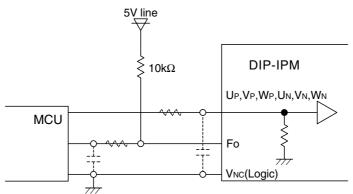
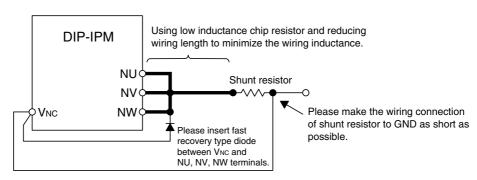


Fig. 6 MCU I/O INTERFACE CIRCUIT



Note: RC coupling at each input (parts shown dotted) may change depending on the PWM control scheme used in the application and the wiring impedance of the application's printed circuit board. The DIP-IPM input signal section integrates a 2.5kΩ(min) pull-down resistor. Therefore, when using a external filtering resistor, pay attention to the turn-on threshold voltage requirement.

Fig. 7 WIRING CONNECTION WITH 1 SHUNT RESISTOR



For 3 shunt resistors connection, please refer to Fig.9.



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Fig. 8 AN EXAMPLE OF TYPICAL DIP-IPM APPLICATION CIRCUT WITH 1 SHUNT RESISTOR

C1:Tight tolerance temp-compensated electrolytic type C2,C3: 0.1~0.22µF R-category ceramic capacitor for noise filtering. (Note: The capacitance value depends on the PWM control used in the applied system.) Vufe DIP-IPM YUF: HVIC1 Ve Е С3 нс HVIC2 :: C3 М HVIC3 VE . Сз н MCU UVN == C3 VVN Wor **★** Iwn CIN 15V line

- Note 1: To avoid malfunction, the wiring of each input should be as short as possible. (less than 2-3cm)
 By virtue of integrating HVIC inside the module, direct coupling to MCU terminals without any opto-coupler or transformer isolation is possible.
 Fo output is open drain type. The signal line should be pulled up to the positive side of a 5V supply with an approximate 10kΩ resistor.
 Fo output pulse width (IFO) should be determined by connecting external capacitor C4 between CFO and VNc terminals. (Example : 4. Fo dulput pulse which (FO) should be determined by connecting external capacitor C4 between CFO and VNC terminals. (Example 1 tFO=2.4ms(typ.) at CFO=22nF)
 5. Input signal is High-Active type. There is a 2.5kΩ (Min.) resistor inside IC to pull down each input signal line to GND. When employing RC coupling circuits at each input, set up RC couple such that input signal agree with turn-off/turn-on threshold voltage.
 6. To prevent errors of the protection function, the wiring of A, B, C should be as short as possible.

 - 7: The time constant R5C1 of the protection circuit should be selected in the range of 1.5~2µs. SC interrupting time might vary with the wiring pattern.
 - 8: All capacitors should be mounted as close to the terminals of the DIP-IPM as possible.
 - 9: To prevent surge destruction, the wiring between the smoothing capacitor and the P&N1 terminals should be as short as possible. Generally a 0.1~0.22µF snubber between the P&N1 terminals is recommended.
 - 10: It is recommended to insert a Zener diode (24V/1W) between each pair of control supply terminals to prevent surge destruction.
 - 11: To prevent LVIC from surge destruction, it is recommended to mount a fast recovery type diode between VNC and NU, NV, NW

Fig. 9 EXAMPLE OF EXTERNAL PROTECTION CIRCUIT WITH 3 SHUNT RESISTORS

